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In re U.S. Patent Application of )

TACHIBANA et. al. )

Application Number: 10/701,499 )

Filed: November 6, 2003 )

For: HEAT SPREADER AND SEMICONDUCTOR )  
DEVICE AND PACKAGE USING THE SAME )

Attorney Docket No. KOBE.0057 )

Art Unit 2814

Examiner  
Rao, Shrinivas H.

Honorable Assistant Commissioner  
for Patents  
Washington, D.C. 20231

**COVER LETTER**

Sir:

[ x ] The fee for submission of claims is calculated as shown below:

FOR	TOTAL WITH NEW CLAIMS ADDED	TOTAL CURRENTLY ON FILE	CLAIMS ALREADY PAID	RATE	CALCULATION
Total Claims	5	12	-XX (Over 20)	x \$50	0
Independent Claims	2	3	-XX (Over 3)	x \$200	0
MULTIPLE DEPENDENT CLAIM(S)				+ \$360	0
REDUCTION FOR FILING BY SMALL ENTITY (note 37 C.F.R. §§ 1.9, 1.27, 1.28).				x 1/2	
				TOTAL	0.00

In addition, the below-identified communications are submitted in the above-captioned application or proceeding:

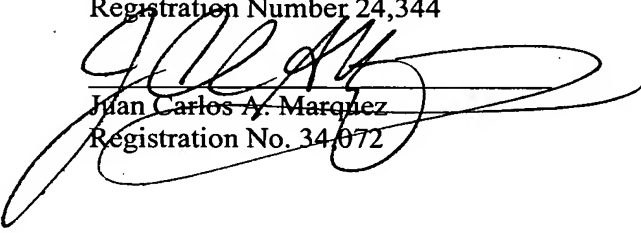
[ x ] Response to Office Action  
(with Claim Amendments)  
[ ] Substitute Specification  
[ ] Preliminary Amendment  
[ ] Information Disclosure Statement

[ ] Petition for Extension of Time  
[ ] Terminal Disclaimer  
[ ] Letter to Draftsperson  
[ ] Assignment  
[ ] Other \_\_\_\_\_

- ☐ Please charge my **Deposit Account Number** \_\_\_\_\_ in the amount of \_\_\_\_\_ to cover the fees for \_\_\_\_\_. A duplicate copy of this paper is enclosed.
- ☐ A check in the amount of **\$0.00** to cover the \_\_\_\_\_ fee is enclosed.
- ☒ The Commissioner is hereby authorized to charge any additional fees associated with this communication, including fees under 37 C.F.R. § 1.16 and 1.17, or credit any overpayment to **Deposit Account Number 08-1480**.

Respectfully submitted,

\_\_\_\_\_  
Stanley P. Fisher  
Registration Number 24,344

  
Juan Carlos A. Marquez  
Registration No. 34,072

**REED SMITH LLP**  
3110 Fairview Park Drive  
Suite 1400  
Falls Church, Virginia 22042  
(703) 641-4200  
**August 10, 2005**



**THE UNITED STATES PATENT AND TRADEMARK OFFICE**

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Honorable Assistant Commissioner  
for Patents  
Washington, D.C. 20231

**RESPONSE AND AMENDMENT UNDER 37 C.F.R. §1.111**

Sir:

This is in response to the office action dated May 24, 2005, in the above identified application, the period for response is set to expire on August 24, 2005. Please amend the above-referenced application as follows: